



TECHNICAL DATASHEET

Hardware Documentation & Development Specifications

ICP-10111 Barometric Pressure Sensor

High-Precision Environmental Sensor Module

Part Number: ICP-10111-001

 Revision:
 Rev. 1.0

 Document Date:
 2025-07-21

DOCUMENT INFORMATION

Document Type	Technical Datasheet	
Classification	Development Documentation	
Project Phase	Prototype & Development	
Technical Author	DevLab Engineering Team	
Review Status	Draft - Under Development	
Distribution	Internal Development Team	

DEVELOPMENT NOTICE

This document describes a prototype hardware module under development. Specifications are preliminary and subject to change during development process.

Not intended for production use without further validation and testing.

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 $\label{lem:condition} Hardware\ Development\ \&\ Prototyping$ $\ Development\ Project\ -\ Contact:\ info@unitelectronics.com$

 $@\ 2025\ Development\ documentation\ -\ All\ specifications\ are\ preliminary \\$

PROJECT INFORMATION & DEVELOPMENT STATUS

REVISION HISTORY

Rev.	Date	Author	Description of Changes
1.0	2025-07-21	DevLab Engineering Team	Initial development documentation

DEVELOPMENT STATUS

• Project Phase: Prototype Development

• Hardware Status: Functional prototype completed

• Testing Status: Basic functionality verified

• Documentation: Preliminary specifications

• Certification: Not yet initiated

FUTURE COMPLIANCE TARGETS

• Design Guidelines: Following IPC-2221 recommendations

• Environmental Goals: RoHS compliance preparation

• Safety Considerations: Basic safety guidelines applied

• EMC Preparation: Layout considerations for future testing

• Quality Process: Development best practices

DEVELOPMENT NOTICES

Project Status:

This hardware module is currently in the prototype development phase. All specifications and characteristics described in this document are preliminary and based on initial testing and design calculations.

Disclaimer:

The information in this document represents the current state of development and is provided for development team reference only. Specifications may change as the project progresses through design validation and testing phases.

Usage Notice:

This prototype is intended for development, testing, and evaluation purposes only. It is not suitable for production applications without further development, validation, and appropriate certifications.

This document follows general technical documentation practices and represents current development status as of the revision date

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Hardware License Information

Open Source Hardware License

License Type: Open Source Hardware

License: MIT License

Copyright: Copyright (c) 2025 UNIT Electronics

Description: This hardware design is released under the MIT License

Permissions:

• Commercial Use: Permitted

• Modification: Permitted

• Distribution: Permitted

Requirements:

• Attribution: Attribution required for derivative works

Limitations:

• Warranty: No warranty provided

Design Standards & IPC Guidelines

IPC Standards Reference

This hardware design follows industry-standard IPC guidelines and best practices:

PCB Design Standards:

- IPC-2221 Generic Standard on Printed Board Design
- IPC-2152 Standard for Determining Current Carrying Capacity in Printed Board Design

Assembly Standards:

- IPC-A-610 Acceptability of Electronic Assemblies
- IPC-J-STD-001 Requirements for Soldered Electrical and Electronic Assemblies

Component Standards:

• IPC-7351 - Generic Requirements for Surface Mount Design and Land Pattern Standard

Testing Standards:

• IPC-TM-650 - Test Methods Manual

Compliance Status (Development Phase)

Environmental Compliance:

- RoHS: Design prepared for RoHS compliance
- REACH: Material selection following REACH guidelines
- Lead-Free: Lead-free assembly process compatible

Note: Development stage - testing in progress

1 1. SCOPE AND PURPOSE

1.1 1.1 Document Scope

This technical datasheet provides comprehensive specifications, electrical characteristics, mechanical dimensions, and application guidelines for the ICP-10111 Barometric Pressure Sensor module. This document is intended for design engineers, system integrators, and technical personnel involved in the development and integration of environmental sensing solutions.

1.2 Product Overview

The ICP-10111 Barometric Pressure Sensor module is a compact embedded sensor with integrated environmental monitoring capabilities, designed for IoT applications and precise atmospheric measurements. The module combines high-accuracy pressure sensing with auxiliary environmental monitoring capabilities in a compact, easy-to-integrate form factor.

1.3 Key Features

- ICP-10111 Pressure Sensor High precision barometric pressure measurement
- BME688 Environmental Sensor Temperature, humidity, and gas sensing capabilities
- Low Power Consumption Optimized for battery-powered applications
- I2C/QWIIC Connectivity Standard digital interface with plug-and-play connector
- Compact Form Factor PCB with castellated holes for flexible mounting options
- Industrial Temperature Range -40to +85operation
- RoHS Compliant Lead-free manufacturing process

2 2. TECHNICAL SPECIFICATIONS

2.1 2.1 Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage	VDD	-0.3	6.0	V	Beyond operating range
Storage Temperature	TSTG	-55	+125		Non-operating
Pressure Range (Absolute)	PABS	0	1500	hPa	Mechanical limit

Table 2: Especificaciones técnicas

WARNING: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2.2 2.2 Recommended Operating Conditions

2.2.1 2.2.1 Sensor Specifications

Parameter	Value	Unit	Notes
Pressure Range	300-1250	hPa	Absolute pressure
Pressure Accuracy	± 0.4	hPa	At 25
Temperature Range	-40 to +85		Operating range
Humidity Range	0-100	Interface	I2C
-	QWIIC compatible		'

Table 3: Especificaciones técnicas

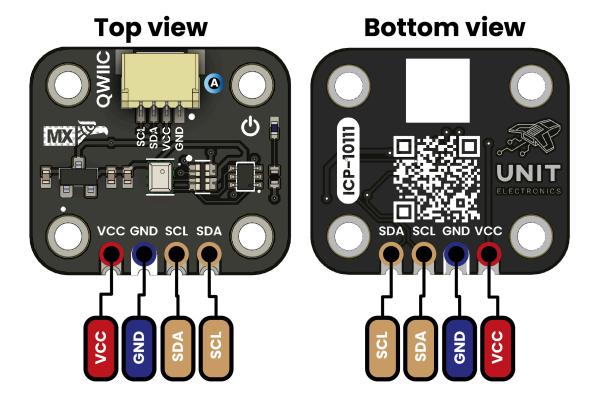
2.2.2 Power Specifications

Parameter	Min	Тур	Max	Unit	Conditions
Supply Voltage	3.0	3.3	5.0	V	Normal Operation
Active Current	_	1.2	2.0	mA	Continuous measurement
Sleep Current	_	0.1	0.5	μ A	Standby mode
Regulator Output	-	1.8	-	V	Internal LDO

Table 4: Especificaciones técnicas

2.3 Pinout

PINOUT



Description:



Figure 1: Pinout Diagram

Pin Label	Function	Notes
VCC	Power Supply	3.3V or 5V
GND	Ground	Common ground for all components
SDA	I2C Data	Serial data line
SCL	I2C Clock	Serial clock line

Table 5: Especificaciones técnicas

2.4 Dimensions

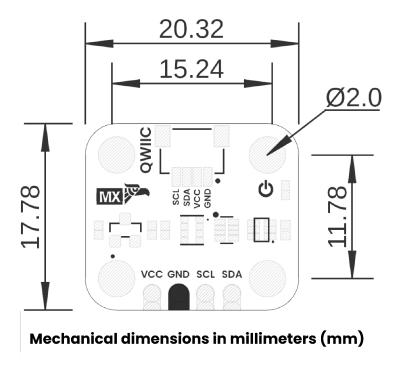
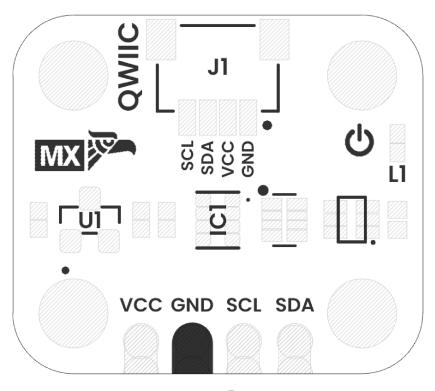


Figure 2: Dimensions

2.5 Topology



JP1
Top View of Board Topology

Figure 3: Topology

Ref.	Description
IC1	ICP-10111 Barometric Pressure Sensor
IC2	BME688 Environmental Sensor
L1	Power On LED
U1	ME6206A18XG 1.8V Regulator
JP1	2.54 mm Castellated Holes
J1	QWIIC Connector (JST 1 mm pitch) for I2C

Table 6: Especificaciones técnicas

2.6 Communication Interfaces

2.6.1 I2C Interface

• Address: 0x63 (ICP-10111), 0x77 (BME688)

• Speed: Standard (100 kHz), Fast (400 kHz)

• Features: QWIIC compatible connector

• Pull-up Resistors: $4.7k\Omega$ integrated

2.6.2 Digital Interface Specifications

• Logic Levels: 3.3V CMOS compatible

• Input High: 2.0V minimum

• Input Low: 0.8V maximum

• Output Drive: 4mA typical

2.7 Physical Characteristics

2.7.1 Package Information

Parameter	Value	Unit
Package Type	Custom PCB	-
Dimensions	$25.4 \times 15.24 \times 3.2$	$_{ m mm}$
Mounting	Castellated holes	2.54mm pitch
Weight	2.1	g

Table 7: Especificaciones técnicas

2.7.2 Environmental Specifications

Parameter	Min	Max	Unit	Conditions
Operating Temperature	-40	+85		Full accuracy
Storage Temperature	-55	+125		-
Humidity	0	100	Pressure Range	300
1250	hPa	Absolute pressure	_	'

Table 8: Especificaciones técnicas

2.8 Software Support

2.8.1 Development Environment

• Arduino IDE: Full library support

• ESP-IDF: Native driver integration

• PlatformIO: Cross-platform support

2.8.2 Key Libraries

- ICP-10111 pressure sensor driver
- BME688 environmental sensor library
- I2C communication protocols
- Data filtering and calibration

2.9 Applications

The ICP-10111 module is ideal for:

1. Weather Monitoring

- Atmospheric pressure measurement
- Altitude determination
- Weather prediction systems

1. IoT Environmental Sensing

- Smart building automation
- Agricultural monitoring
- Air quality assessment

1. Portable Devices

- Fitness trackers
- Outdoor navigation devices
- Drone altitude control

2.10 Safety and Compliance

2.10.1 Certifications

- RoHS: Compliant with EU directive
- REACH: Compliant with EU regulation
- CE: Electromagnetic compatibility

2.10.2 Safety Features

- ESD Protection: $\pm 2kV$ HBM on all pins
- Reverse Polarity Protection: Integrated
- Thermal Protection: Operating range monitoring

2.11 References

- ICP-10111 Datasheet
- BME688 Datasheet
- ME6206 Regulator Datasheet

2.12 Ordering Information

Part Number	Description	Package	MOQ
ICP10111-001	Standard Module	Individual	1
ICP10111-DEV	Development Kit	Kit Box	1
ICP10111-BULK	Bulk Order	Tray	100

Table 9: Especificaciones técnicas

2.13 Revision History

	Version	Date	Changes
ſ	1.0	2025-07-18	Initial release

Table 10: Especificaciones técnicas

2.14 Schematics

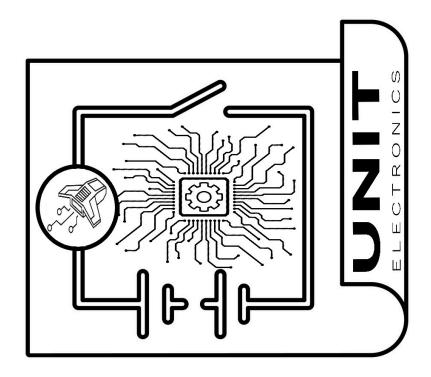


Figure 4: Circuit Schematic

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 $For \ technical \ support \ and \ additional \ information, \ visit \ our \ website \ or \ contact \ our \ engineering \\ team.$

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